Products Documentation Resources My Account Customer Support

Home > Products > Backplane/Midplane > Product Feature Selector > Product Details

5223004-5 Product Details

Have a Question?

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Quick Links

Check Pricing & Availability Search for Tooling View Mating Products (4) Product Feature Selector

Contact Us About This Product





2mm Centerline Futurebus+ Connectors

Always EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Module Type = Signal 150 Signal Positions Connector
- Housing · Free-Board Application

View all Features











🔁 <u>View 3D PDF</u>

Documentation & Additional Information

Product Drawings:

ASSEMBLY, RECEPTACLE, SIGNAL, RIGHT ANGLE, Z-PACK 2m... (PDF, English)

Catalog Pages/Data Sheets:

Product Specifications:

Connector, Z-PACK*, 2 mm FB, Signal and Power (PDF, English)

Application Specifications:

Z-PACK 2mm FB (Futurebus+) Receptacle and Pin Header... (PDF, English)

Instruction Sheets:

CAD Files: (CAD Format & Compression Information)

- 2D Drawing (DXF, Version O)
 3D Model (IGES, Version O)
- 3D Model (STEP, Version O)

List all Documents

Additional Information:

Product Line Information

Related Products:

- Tooling
- Mating Products (4)

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Product Type = Connector
- Connector Type = Housing
- PCB Mount Angle = Right Angle
- Post Type = Solder Post

Mechanical Attachment:

Module Type = Signal

Electrical Characteristics:

Voltage Rating (VAC) = 30

Termination Related Features:

Termination Post Length (mm [in]) = 2.73 [0.107]

Body Related Features:

- Number of Signal Positions = 150
- Sequencing = No
- Number of Rows = 5
- Post Plating = Tin
- Centerline, Matrix (mm [in]) = 2.00 x 2.00 [.079 x .079]

Contact Related Features:

- Contact Gender = Receptacle
- Contact Base Material = Phosphor Bronze
- Contact Plating, Mating Area, Material = Gold (30)

Housing Related Features:

- Housing Gender = Receptacle
- Housing Material = Liquid Crystal Polymer (LCP)

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Wave solder capable to 240°C, Wave solder capable to 260°C, Wave solder capable to 265°C, Reflow solder capable to 245°C, Reflow solder capable to 245°C, Pin-in-Paste capable to 260°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Conditions for Usage:

• Applies To = Printed Circuit Board

Operation/Application: • Application = Free-Board

Other:
• Brand = AMP



Corporate Information **Quick Links**

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Product Compliance Support Center

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